

Rochester Electronics Manufactured Components

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All recreations are done with the approval of the OCM.

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceed the OCM data sheet.

Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-35835
 - Class Q Military
 - Class V Space Level
- Qualified Suppliers List of Distributors (QSLD)
 - Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OEM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

DM74LS75 Quad Latch

General Description

These latches are ideally suited for use as temporary storage for binary information between processing units and input/output or indicator units. Information present at a data (D) input is transferred to the Q output when the enable is HIGH, and the Q output will follow the data input as long as the enable remains HIGH. When the enable goes LOW, the information (that was present at the data input at the time the transition occurred) is retained at the Q output until the enable is permitted to go HIGH.

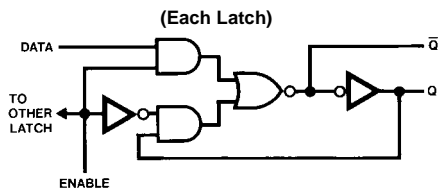
These latches feature complementary Q and \bar{Q} outputs from a 4-bit latch, and are available in 16-pin packages.

Ordering Code:

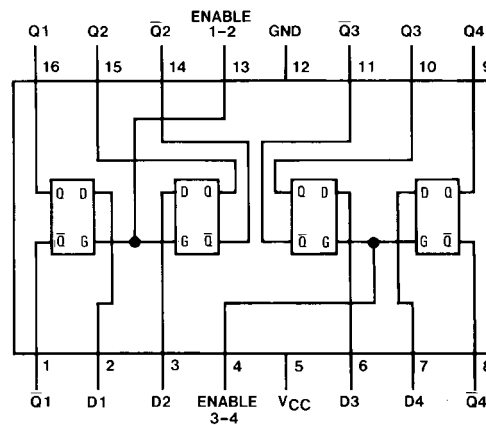
Order Number	Package Number	Package Description
DM74LS75M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
DM74LS75N	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Diagram



Connection Diagram



Function Table (Each Latch)

Inputs		Outputs	
D	Enable	Q	\bar{Q}
L	H	L	H
H	H	H	L
X	L	Q_0	\bar{Q}_0

H = HIGH Level
L = LOW Level
X = Don't Care
 Q_0 = The Level of Q Before the HIGH-to-LOW Transition of ENABLE

Absolute Maximum Ratings(Note 1)

Supply Voltage	7V
Input Voltage	7V
Operating Free Air Temperature Range	0°C to +70°C
Storage Temperature Range	-65°C to +150°C

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Recommended Operating Conditions

Symbol	Parameter	Min	Nom	Max	Units
V _{CC}	Supply Voltage	4.75	5	5.25	V
V _{IH}	HIGH Level Input Voltage	2			V
V _{IL}	LOW Level Input Voltage			0.8	V
I _{OH}	HIGH Level Output Current			-0.4	mA
I _{OL}	LOW Level Output Current			8	mA
t _W	Enable Pulse Width (Note 5)	20			ns
t _{SU}	Setup Time (Note 5)	20			ns
t _H	Hold Time (Note 5)	0			ns
T _A	Free Air Operating Temperature	0		70	°C

Electrical Characteristics

over recommended operating free air temperature range (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ (Note 2)	Max	Units
V _I	Input Clamp Voltage	V _{CC} = Min, I _I = -18 mA			-1.5	V
V _{OH}	HIGH Level Output Voltage	V _{CC} = Min, I _{OH} = Max V _{IL} = Max, V _{IH} = Min	2.7	3.5		V
V _{OL}	LOW Level Output Voltage	V _{CC} = Min, I _{OL} = Max V _{IL} = Max, V _{IH} = Min I _{OL} = 4 mA, V _{CC} = Min		0.35 0.25	0.5 0.4	V
I _I	Input Current @ Max Input Voltage	V _{CC} = Max, V _I = 7V	D Enable		0.1 0.4	mA
I _{IH}	HIGH Level Input Current	V _{CC} = Max, V _I = 2.7V	D Enable		20 80	μA
I _{IL}	LOW Level Input Current	V _{CC} = Max, V _I = 0.4V	D Enable		-0.4 -1.6	mA
I _{OS}	Short Circuit Output Current	V _{CC} = Max (Note 2)		-20	-100	mA
I _{CC}	Supply Current	V _{CC} = Max (Note 3)		6.3	12	mA

Note 2: All typicals are at V_{CC} = 5V, T_A = 25°C.

Note 3: Not more than one output should be shorted at a time, and the duration should not exceed one second.

Note 4: I_{CC} is measured with all outputs open and all inputs grounded.

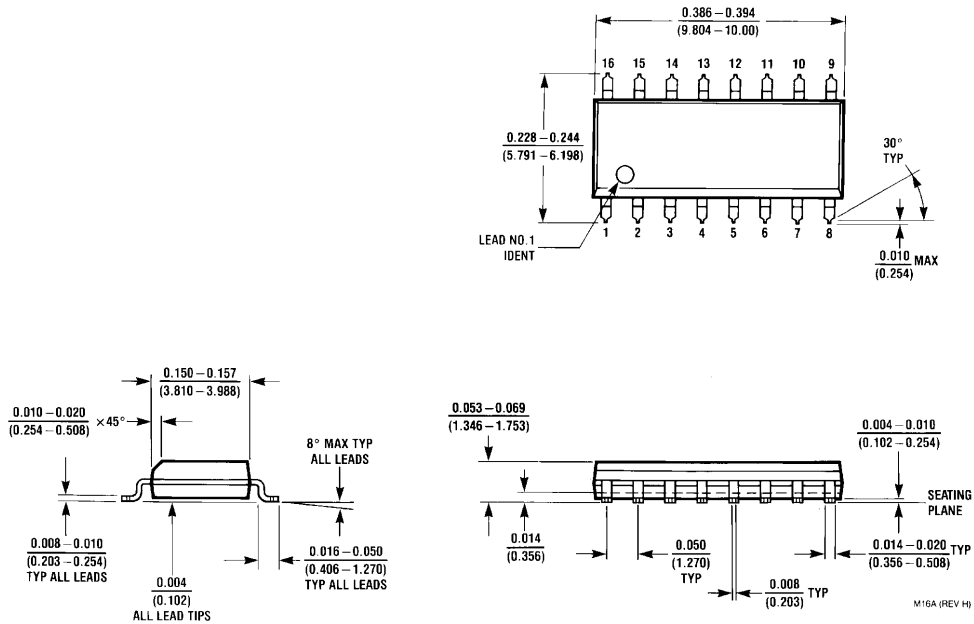
Note 5: T_A = 25°C and V_{CC} = 5V.

Switching Characteristics

at $V_{CC} = 5V$ and $T_A = 25^\circ C$

Symbol	Parameter	From (Input) To (Output)	$R_L = 2\text{ k}\Omega$				Units
			$C_L = 15\text{ pF}$		$C_L = 50\text{ pF}$		
			Min	Max	Min	Max	
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	D to Q		27		30	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	D to Q		17		25	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	D to \bar{Q}		20		25	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	D to \bar{Q}		15		20	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	Enable to Q		27		30	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	Enable to Q		25		30	ns
t_{PLH}	Propagation Delay Time LOW-to-HIGH Level Output	Enable to \bar{Q}		30		30	ns
t_{PHL}	Propagation Delay Time HIGH-to-LOW Level Output	Enable to \bar{Q}		15		20	ns

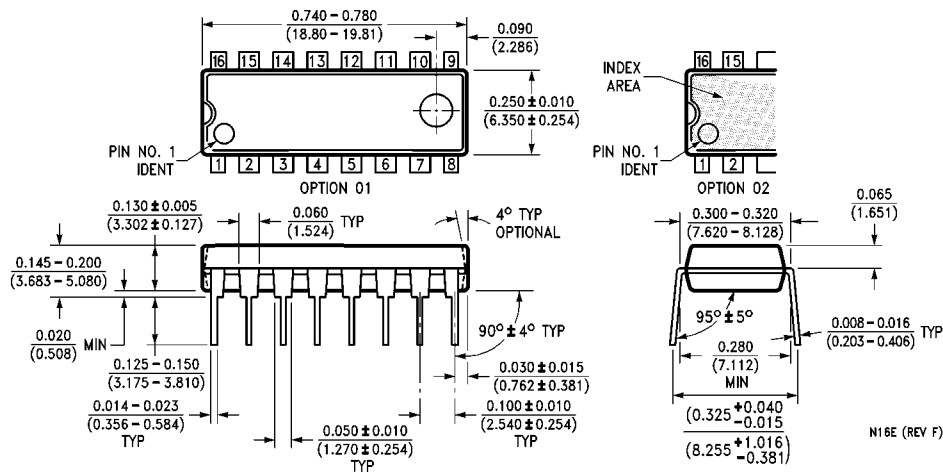
Physical Dimensions inches (millimeters) unless otherwise noted



**16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
Package Number M16A**

M16A (REV H)

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide Package Number N16E

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